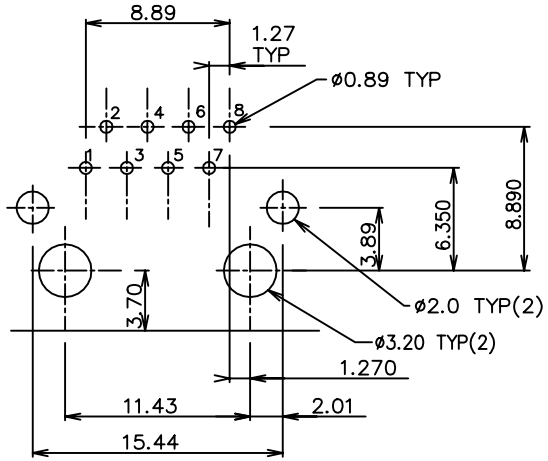
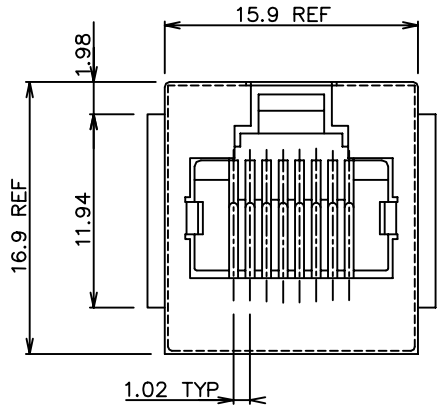
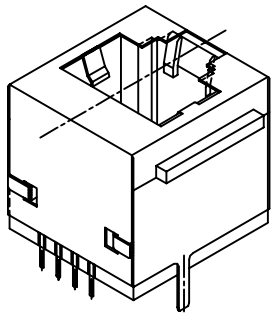
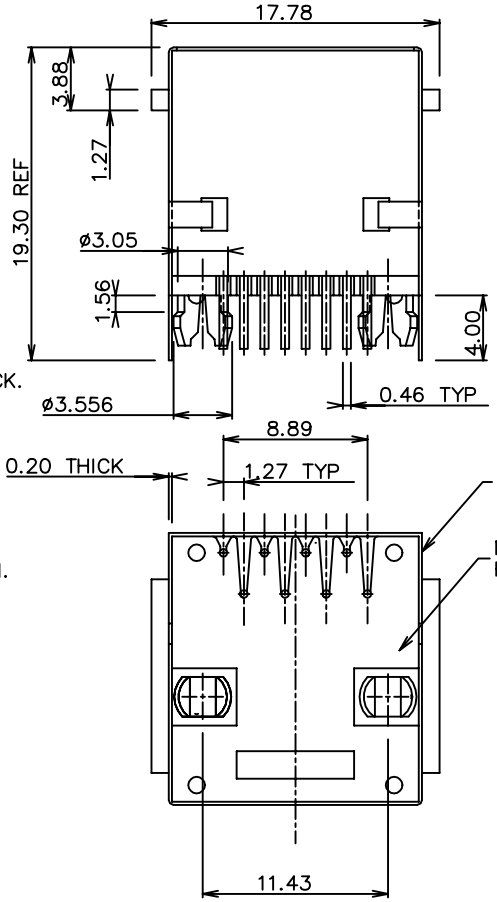
| P/N | WIRE NUMBERS LOADED | PLATING |
|---|---|---|
| 94152-088<br>94152-088LF | ALL | 30 υ" G.X.T. |
| 94152-188LF | ALL | 6 υ" GOLD |

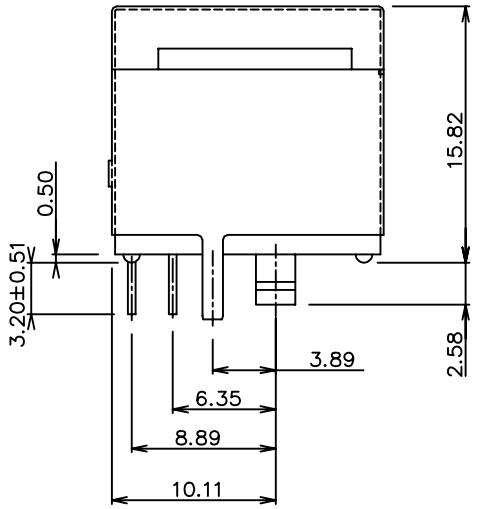



RECOMMENDED PC BOARD LAYOUT






NOTES:

1. RECOMMENDED P.C.B THICKNESS 1.60 MM
2. HOUSING MAT'L: NYLON 66, 25% G.F UL 94V-0, BLACK.
3. CONTACTS: PHOS BRONZE ALLOY UNS-C51000,
   ø 0.460 ROUND WIRE, PLATING SEE TABLE.
4. METAL SHELL MATERIAL:
   COPPER ALLOY. 0.20mm THICK
   FINISH:
   FOR 94152-XXX TIN-LEAD 100u" THICK MIN.
   FOR 94152-XXXLF PURE TIN 80u" THICK MIN.
5. PACKAGING: GES-14-351, USE TRAY
6. ALL DIMENSIONS IN MILIIMETER.
7. IF LF P/N THE PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.
8. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.60mm MINIMUM THICK CIRCUIT BOARD.
9. IF LF P/N PACKAGING MEETS GS-14-920 SPECIFICATION.

| rev. | ecn no. | dr | date |
|---|---|---|---|
| A | T40135 | | 05/19/94 |
| B | T50378 | C L | 12/18/95 |
| C | T03-0443 | WL | 10/06/03 |
| D | N05-0030 | YS | 02/05/05 |
| E | N06-0319 | WG | 12/28/06 |

| | | |
|---|---|---|
| mat'l code | tolerance unless otherwise specified | CUSTOMER COPY |
| linear | .0 ± 0.25<br>.00 ± 0.13<br>.000± 0.05 | projection |
| angles | ± 2° | unit mm/inch |
| scale | 3/1 | |

| | | |
|---|---|---|
| dr | KCHOU | 09/16/93 |
| engr | TONY CHIEN | 09/16/93 |
| chr | TONY CHIEN | 09/16/93 |
| appd | JENN TSAO | 09/16/93 |

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title: 8 POS VERT P.C.B. M/J ASSY SHIELDED

product family

code: TWN

size: A3 | dwg no.: 94152 | sheet: 1 OF 1

| sheet | revision |
|---|---|
| index | sheet 1 |

E

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